

## RX Family

### LPC Module Using Firmware Integration Technology

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#### Introduction

The RX Family has a variety of options that allow the user to conserve power. This FIT-compliant module provides an API that allows the user to easily configure the RX Family CPUs into their various low power consumption modes and operating power control modes. The module also supports Sleep mode Return Clock Switching. This application note describes the Low Power Consumption (LPC) module API including usage examples.

#### Target Device

The following is a list of devices that are currently supported by this API:

- RX110, RX111, RX113 Groups
- RX130 Group
- RX140 Group
- RX14T Group
- RX230, RX231 Groups
- RX23E-B Group
- RX23W Group
- RX26T Group
- RX260, RX261 Groups
- RX64M Group
- RX65N Group
- RX660 Group
- RX66N Group
- RX671 Group
- RX71M Group
- RX72M Group
- RX72N Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

#### Target Compilers

- Renesas Electronics C/C++ Compiler Package for RX Family
- GCC for Renesas RX
- IAR C/C++ Compiler for Renesas RX

For details of the confirmed operation contents of each compiler, refer to “6.1 Confirmed Operation Environment”.

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## 1. Overview

### 1.1 LPC FIT Module

The LPC FIT module can be used by being implemented in a project as an API. See section 2.12 Adding the FIT Module to Your Project for details on methods to implement this FIT module into a project.

### 1.2 Overview of the LPC FIT Module

The operating power control modes for the supported RX CPUs are given in the following table:

**Table 1.1 Operating Power Control modes**

Supported Operating Power Control modes				
<b>RX110, RX111, RX113, RX130, RX230, RX231, RX23E-B, RX23W</b>	<b>RX140, RX260, RX261</b>	<b>RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N</b>	<b>RX14T</b>	<b>RX660, RX26T</b>
High Speed Middle Speed Low Speed	High Speed Middle Speed Middle Speed 2 Low Speed	High Speed Low Speed 1 Low Speed 2	High Speed Middle Speed	No control mode

Each of the operating power control modes has upper and lower limits on the Vcc requirements and the maximum internal clock frequencies supported.

For the RX110, RX111, RX113, for example in High Speed Mode, all the internal clocks can be configured for the system maximum of 32 MHz (when  $3.6V > V_{cc} \geq 2.7$ ) whereas in Middle Speed Mode, the maximum speeds are limited to 12 MHz (when  $3.6V > V_{cc} \geq 2.4$ ). In the Low Speed Mode, only the Sub-Clock can be used as the system clock and all internal clocks are limited to a maximum of 32.768 kHz.

The voltage-frequency requirements vary across the RX Family and individual requirements can be found in the specific hardware manual.

In addition to the “Operating” Power Control modes, several Low Power Consumption modes also exist where the CPU is inactive (not operating), namely:

**Table 1.2 Low Power Consumption modes**

Supported Low Power Consumption modes			
<b>RX110, RX111, RX113, RX130, RX14T, RX230, RX231, RX23E-B, RX23W</b>	<b>RX140, RX260, RX261</b>	<b>RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N</b>	<b>RX26T</b>
Sleep Deep Sleep Software Standby	Sleep Deep Sleep Software Standby Snooze	Sleep All-Module Clock Stop Software Standby Deep Software Standby	Sleep All-Module Clock Stop Software Standby

In each of these modes, certain peripherals are limited or disabled.

## 1.3 Using the LPC FIT module

### 1.3.1 Using LPC FIT module in C++ project

For C++ project, add LPC FIT module interface header file within extern "C":

```
extern "C"
{
    #include "r_smc_entry.h"
    #include "r_lpc_rx_if.h"
}
```

## 1.4 API Overview

Table 1.3 lists the API functions included in this module.

**Table 1.3 API Functions**

Function	Description
<a href="#">R_LPC_OperatingModeSet ()</a>	Configures the MCU for the different supported Operating Power Control modes. See Table 1.1 Operating Power Control modes.
<a href="#">R_LPC_LowPowerModeConfigure ()</a>	Configures the MCU for the different Low Power Consumption modes. See Table 1.2: Low Power Consumption modes.
<a href="#">R_LPC_LowPowerModeActivate ()</a>	Enables the Low Power Mode configured by R_LPC_LowPowerModeConfigure ()
<a href="#">R_LPC_SnoozeModeConfigure ()</a>	Select the conditions for transition to the snooze mode, return to the software standby mode, or release from the snooze mode.
<a href="#">R_LPC_ReturnClockSwitch ()</a>	Configures Sleep mode return clock switching
<a href="#">R_LPC_GetVersion ()</a>	Returns at runtime the driver version number.

### 1.5 State Transition Diagram

Figure 1.1, Figure 1.2, Figure 1.3, Figure 1.4, Figure 1.5, and Figure 1.6 shows the state transition diagram for this module.

The following charts show a high level view of the Operating Power Control modes and Low Power Consumption modes as well as the LPC API calls that allow for switching between the modes.

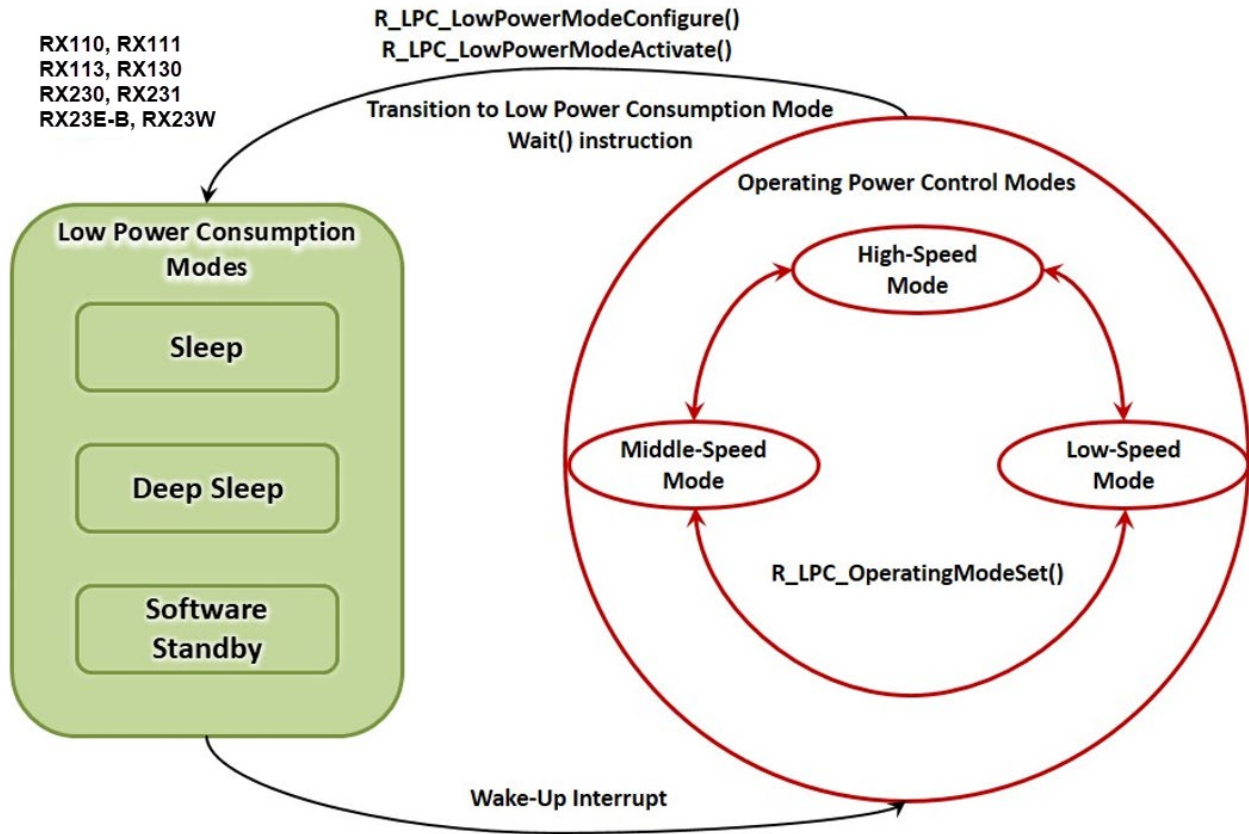


Figure 1.1 LPC API Overview (RX110, RX111, RX113, RX130, RX230, RX231, RX23E-B, RX23W)

RX14T

R\_LPC\_LowPowerModeConfigure ()  
R\_LPC\_LowPowerModeActivate ()

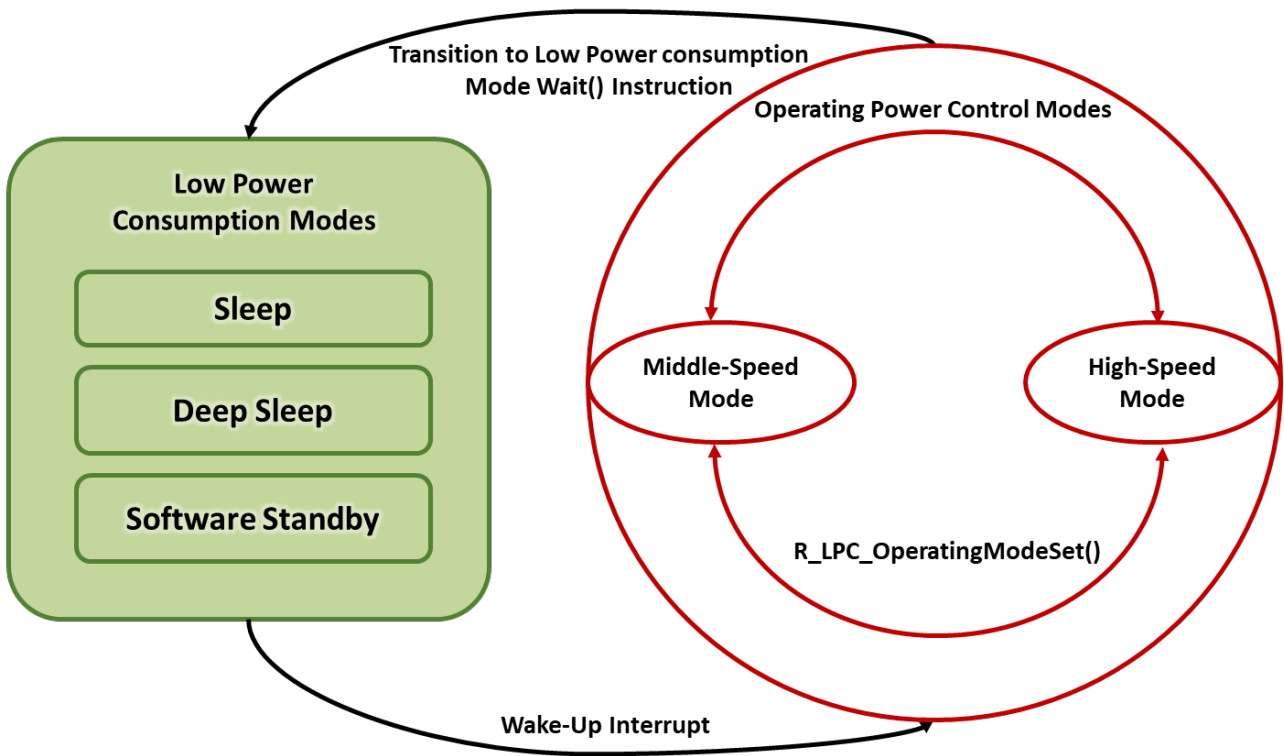


Figure 1.2 LPC API Overview (RX14T)

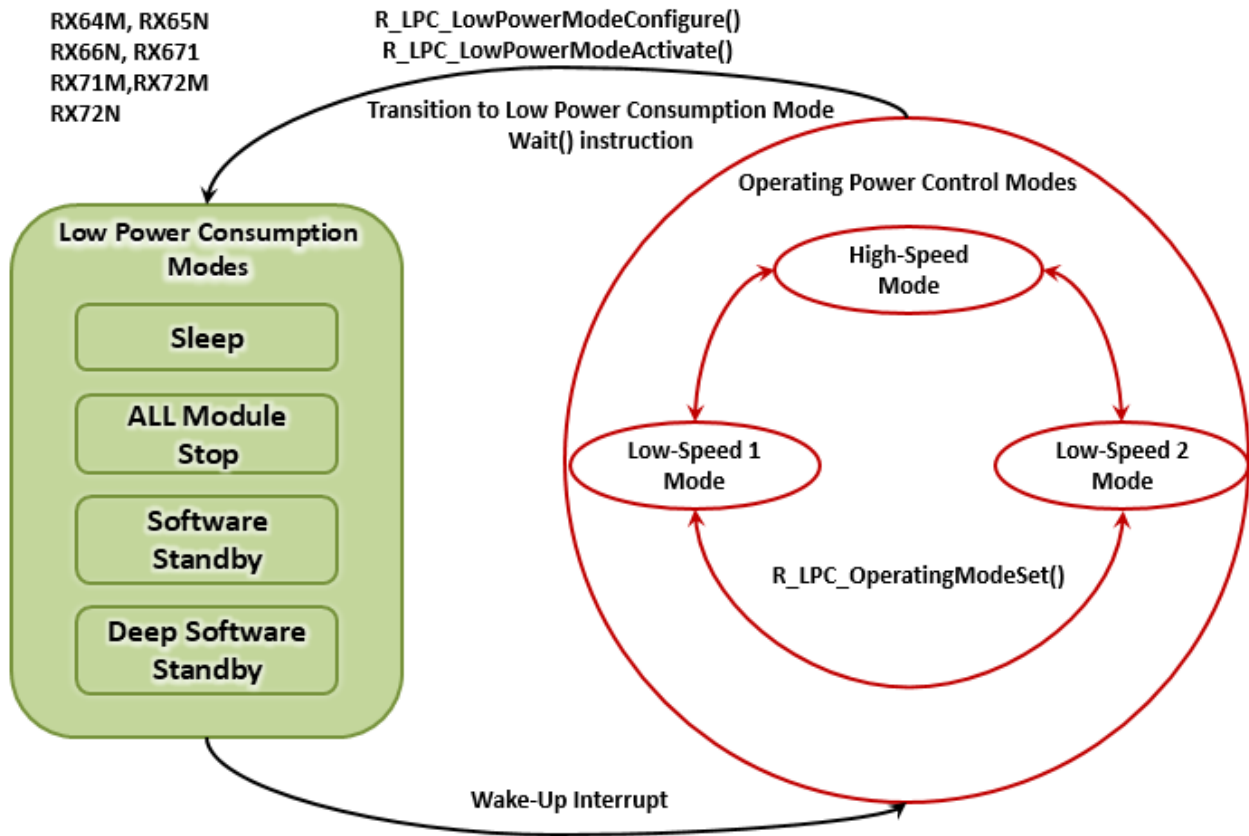


Figure 1.3 LPC API Overview (RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N)

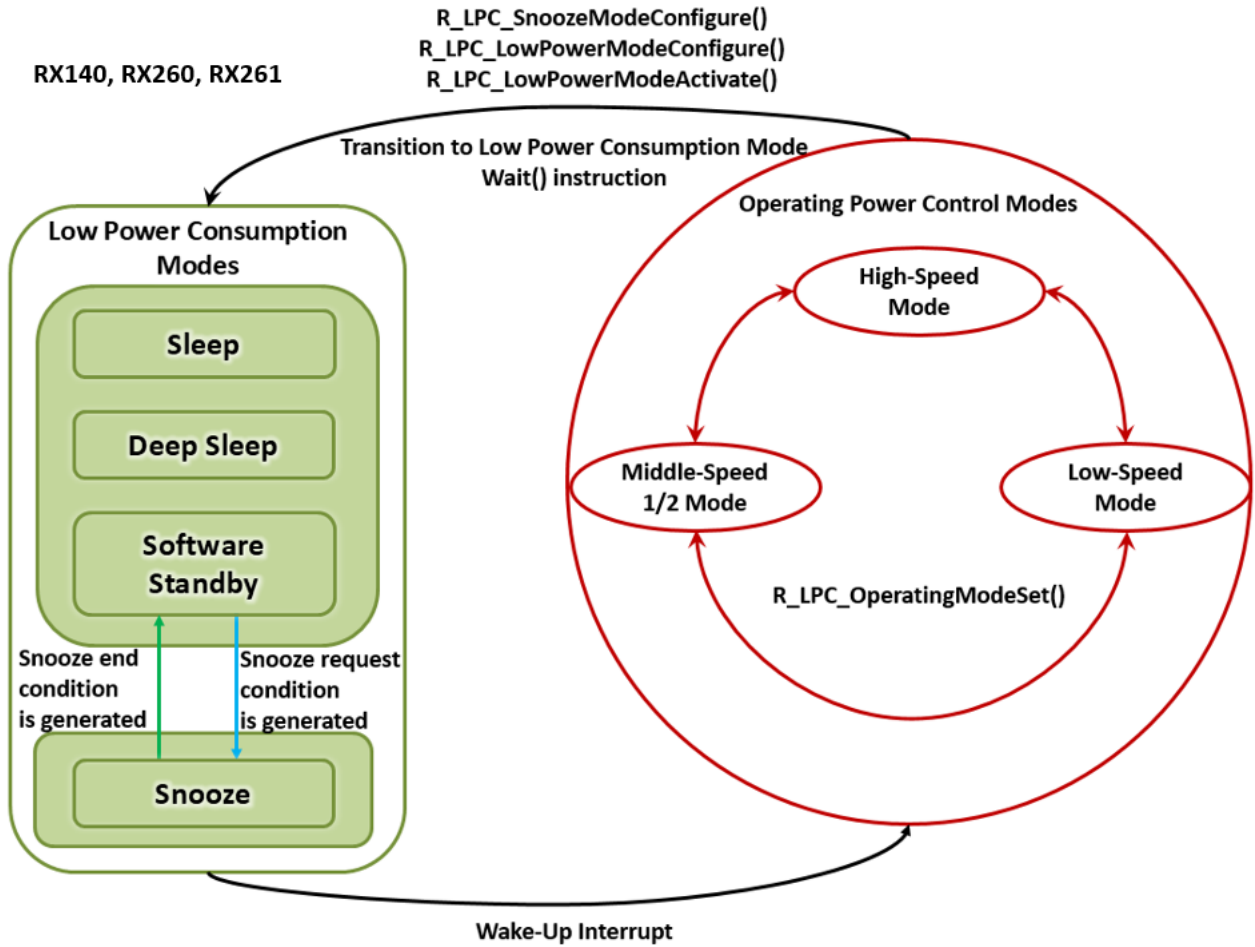


Figure 1.4 LPC API Overview (RX140, RX260, RX261)

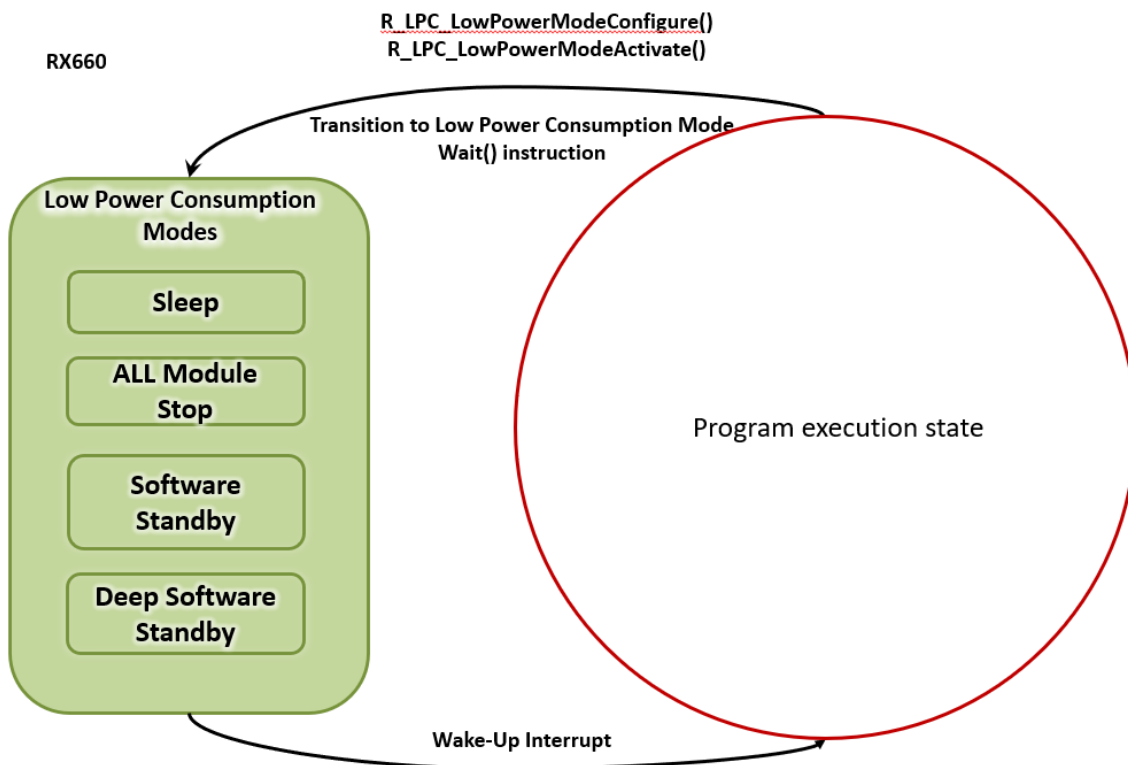


Figure 1.5 LPC API Overview (RX660)

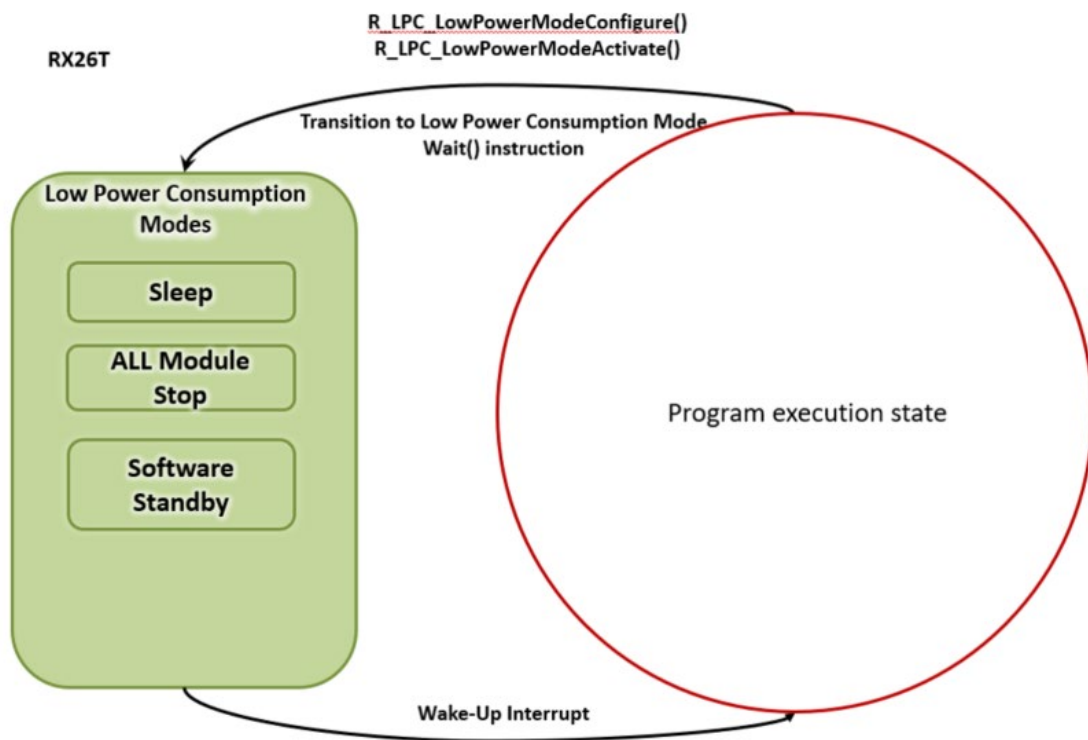


Figure 1.6 LPC API Overview (RX26T)

## 2. API Information

This FIT module has been confirmed to operate under the following conditions.

### 2.1 Hardware Requirements

The MCU used must support the following functions:

- Switching the Operating Power Control Modes given in [Table1 in section 1](#):
- Switching Low Power Consumption Modes given in [Table2 in section 1](#):

### 2.2 Software Requirements

This driver is dependent upon the following FIT module:

- Renesas Board Support Package (r\_bsp) v5.20 or higher

### 2.3 Supported Toolchains

This driver has been confirmed to work with the toolchain listed in 6.1, Confirmed Operation Environment.

### 2.4 Interrupt Vector

Executing the R\_LPC\_SnoozeModeConfigure () function will enable the snooze release interrupt according to the parameter setting.

Table 2-1 list the interrupt vector used in the FIT Module.

**Table 2.1 Interrupt Vector**

Device	Interrupt Vector
RX140, RX260, RX261	Snooze release interrupt (vector number: 81)

### 2.5 Header Files

All API calls and their supporting interface definitions are located in "r\_lpc\_rx\_if.h".

### 2.6 Integer Types

This project uses ANSI C99. These types are defined in stdint.h.

## 2.7 Configuration Overview

The configuration option settings of this module are located in "r\_lpc\_rx\_config.h". The option names and setting values are listed in the table below:

**Table 2.2 Info about the configuration**

Configuration options in r_lpc_rx_config.h		
#define	Default Value	Description
LPC_CFG_PARAM_CHECKING_ENABLE	1	If this equate is set to 1, parameter checking is included in the build. If the equate is set to 0, the parameter checking is omitted from the build. Setting this equate to BSP_CFG_PARAM_CHECKING_ENABLE utilizes the system default setting.

## 2.8 Code Size

The sizes of ROM, RAM and maximum stack usage associated with this module are listed below. Information is listed for a single representative device of the RX100 Series, RX200 Series and RX600 Series, respectively.

The ROM (code and constants) and RAM (global data) sizes are determined by the build-time configuration options described in 2.7, Configuration Overview.

The values in the table below are confirmed under the following conditions.

Module Revision: r\_lpc\_rx rev2.60

Compiler Version: Renesas Electronics C/C++ Compiler Package for RX Family V3.07.00

(The option of “-lang = c99” is added to the default settings of the integrated development environment.)

GCC for Renesas RX 14.2.0.202505

(The option of “-std=gnu99” is added to the default settings of the integrated development environment.)

IAR C/C++ Compiler for Renesas RX version 5.20.1

(The default settings of the integrated development environment.)

Configuration Options: Default settings

ROM, RAM and Stack Code Sizes							
Device	Category	Memory Used					
		Renesas Compiler		GCC		IAR Compiler	
		With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking
RX14T	ROM (Note 1)	6010 bytes	5552 bytes	6916 bytes	6156 bytes	5280 bytes	4576 bytes
	RAM (Note 1)	3068 bytes	3028 bytes	2876 bytes	2836 bytes	4408 bytes	4368 bytes
	STACK (Note 2)	4 bytes		-		52 bytes	
RX261	ROM (Note 1)	7134 bytes	6374 bytes	8524 bytes	7348 bytes	6794 bytes	5618 bytes
	RAM (Note 1)	6990 bytes	6950 bytes	6808 bytes	6768 bytes	4492 bytes	4452 bytes
	STACK (Note 2)	4 bytes		-		52 bytes	
RX64M	ROM (Note 1)	9175 bytes	8300 bytes	12340 bytes	10844 bytes	10171 bytes	8879 bytes
	RAM (Note 1)	7520 bytes	7480 bytes	7420 bytes	7420 bytes	2204 bytes	2164 bytes
	STACK (Note 2)	4 bytes		-		56 bytes	

Note 1: The above ROM or RAM size includes ROM / RAM size of BSP FIT module.

Note 2: The above STACK size doesn't include stack size of BSP FIT module.

## 2.9 Parameters

This section describes the parameter structure used by the API functions in this module. The enumeration type is located in `r_lpc_[device]_if.h` (ex: `r_lpc_rx64m_if.h`) as are the prototype declarations of API functions.

### 2.9.1 R\_LPC\_OperatingModeSet Data Types

```

/* Operating power control modes for RX110, RX111, RX113, RX130, RX230, RX231,
RX23E-B, RX23W */
typedef enum lpc_operating_mode
{
    LPC_OP_HIGH_SPEED      = 0x00,
    LPC_OP_MIDDLE_SPEED    = 0x02,
    LPC_OP_LOW_SPEED       = 0x06,
    LPC_OP_INVALID_MODE
} lpc_operating_mode_t;

/* Operating power control modes for RX64M, RX65N, RX66N, RX671, RX71M, RX72M,
RX72N */
typedef enum lpc_operating_mode{
    LPC_OP_HIGH_SPEED      = 0x00,
    LPC_OP_LOW_SPEED_1     = 0x06,
    LPC_OP_LOW_SPEED_2     = 0x07,
    LPC_OP_INVALID_MODE
} lpc_operating_mode_t;

/* Operating power control modes for RX140, RX260, RX261 */
typedef enum lpc_operating_mode
{
    LPC_OP_HIGH_SPEED = 0x00,
    LPC_OP_MIDDLE_SPEED = 0x02,
    LPC_OP_MIDDLE_SPEED_2 = 0x04,
    LPC_OP_LOW_SPEED = 0x06,
    LPC_OP_INVALID_MODE
}lpc_operating_mode_t;

/* Operating power control modes for RX14T */
typedef enum lpc_operating_mode
{
    LPC_OP_HIGH_SPEED      = 0x00,
    LPC_OP_MIDDLE_SPEED    = 0x02,
    LPC_OP_INVALID_MODE
} lpc_operating_mode_t;

```

### 2.9.2 R\_LPC\_LowPowerModeConfigure Data Types

```

/* Low Power Modes for RX110, RX111, RX113, RX130, RX140, RX14T, RX230, RX231,
RX23E-B, RX23W, RX260, RX261 */
typedef enum lpc_low_power_mode
{
    LPC_LP_SLEEP,
    LPC_LP_DEEP_SLEEP,
    LPC_LP_SW_STANDBY,
    LPC_LP_INVALID_MODE
} lpc_low_power_mode_t;

/* Low Power Modes for RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N */
typedef enum lpc_low_power_mode{
    LPC_LP_SLEEP,
    LPC_LP_ALL_MODULE_STOP,
    LPC_LP_SW_STANDBY,
    LPC_LP_DEEP_SW_STANDBY,

```

```

    LPC_LP_INVALID_MODE
}lpc_low_power_mode_t;

/* Low Power Modes for RX26T */
typedef enum lpc_low_power_mode{
    LPC_LP_SLEEP,
    LPC_LP_ALL_MODULE_STOP,
    LPC_LP_SW_STANDBY,
    LPC_LP_INVALID_MODE
}lpc_low_power_mode_t;

```

### 2.9.3 R\_LPC\_ReturnClockSwitch Data Types

```

/* LPC Sleep Mode Return Clock Switching Sources for RX110, RX111, RX113, RX130,
RX140, RX230, RX231, RX23E-B, RX23W, RX260, RX261 */
typedef enum lpc_clock_switch{
    LPC_LOCO      = 0x00,
    LPC_HOCO      = 0x01,
    LPC_MAIN_OSC = 0x02,
}lpc_clock_switch_t;

/* LPC Sleep Mode Return Clock Switching Sources for RX64M, RX65N, RX660, RX66N,
RX671, RX71M, RX72M, RX72N, RX26T */
typedef enum lpc_clock_switch{
    LPC_HOCO      = 0x01,
    LPC_MAIN_OSC = 0x02,
}lpc_clock_switch_t;

```

### 2.9.4 R\_LPC\_SnoozeModeConfigure Data Types

```

/* Conditions for transition to snooze mode, return to software standby mode,
and snooze mode release interrupt for RX140, RX260, RX261 */
typedef struct st_lpc_snooze_mode
{
    uint16_t snooze_operation;
    uint16_t snooze_release;
    lpc_snooze_interrupt_t snooze_interrupt;
} lpc_snooze_mode_t;

typedef struct st_lpc_snooze_interrupt
{
    uint8_t priority;
    lpc_snooze_callback_set_t pcallback;
} lpc_snooze_interrupt_t;

```

---

## 2.10 Return Values

---

This describes the parameter structure used by the API functions in this module. The enumeration type is located in `r_lpc_rx_if.h` as are the prototype declarations of API functions.

```
/* LPC API error codes */
typedef enum lpc_err
{
    LPC_SUCCESS,
    LPC_ERR_OSC_STOP_ENABLED, // Software Standby cannot be entered if osc stop is enabled.
    LPC_ERR_CLOCK_EXCEEDED, // Clock exceeds the limit of the operating power control
                             // mode.
    LPC_ERR_ILL_MAIN_CLK_FREQ, // Clock freq. exceeds the limit of the sleep return clock.
    LPC_ERR_ILL_CLOCK_SOURCE, // Illegal clock when sleep mode return clock switching
                             // is enabled
    LPC_ERR_P_E_MODE, // The operating power control mode cannot be switched while
                     // the flash memory is being programmed or erased (P/E).
    LPC_ERR_DEEP_SLEEP_STATUS, // The condition error for a deep sleep mode.
    LPC_ERR_ILL_PARAM // (Not used)
    LPC_ERR_ILLEGAL // Illegal operation
} lpc_err_t;
```

---

## 2.11 Callback Function

---

In this module, the callback function set by the user is called at the timing explained below. Callback functions are set in each function.

1. Call the callback function before transitioning to the low power state.  
For details, refer to "R\_LPC\_LowPowerModeActivate ()" in "3 API Functions".
2. Call the callback function when the snooze release interrupt occurs.  
For details, refer to "R\_LPC\_SnoozeModeConfigure ()" in "3 API Functions".

---

## 2.12 Adding the FIT Module to Your Project

---

This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) or (2) or (4) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (3) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e<sup>2</sup> studio  
By using the Smart Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: e<sup>2</sup> studio (R20AN0451)" for details.
- (2) Adding the FIT module to your project using the Smart Configurator in CS+  
By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: CS+ (R20AN0470)" for details.
- (3) Adding the FIT module to your project in CS+  
In CS+, please manually add the FIT module to your project. Refer to "RX Family Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)" for details.
- (4) Adding the FIT module to your project using the Smart Configurator in IAREW  
By using the Smart Configurator Standalone version, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: IAREW (R20AN0535)" for details.

## 2.13 “for”, “while” and “do while” statements

In this module, “for”, “while” and “do while” statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with “WAIT\_LOOP” as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with “WAIT\_LOOP”.

The following shows example of description.

```
while statement example :
/* WAIT_LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}

for statement example :
/* Initialize reference counters to 0. */
/* WAIT_LOOP */
for (i = 0; i < BSP_REG_PROTECT_TOTAL_ITEMS; i++)
{
    g_protect_counters[i] = 0;
}

do while statement example :
/* Reset completion waiting */
do
{
    reg = phy_read(ether_channel, PHY_REG_CONTROL);
    count++;
} while ((reg & PHY_CONTROL_RESET) && (count < ETHER_CFG_PHY_DELAY_RESET)); /* WAIT_LOOP */
```

### 3. API Functions

#### R\_LPC\_OperatingModeSet ()

This function configures the MCU for the supported Operating Power Control modes (See [Table 1.1 Operating Power Control modes](#)).

#### Format

```
lpc_err_t R_LPC_OperatingModeSet (
    lpc_operating_mode_t e_mode
)
```

#### Parameters

*lpc\_operating\_mode\_t e\_mode*

The modes for all supported MCUs are specified in enum [lpc\\_operating\\_mode\\_t](#) in section 2.9.1.

#### Return Values

*LPC\_SUCCESS:*

*LPC\_ERR\_CLOCK\_EXCEEDED:*

*// Clock exceeds the limit of the operating power control mode.*

*LPC\_ERR\_P\_E\_MODE:*

*// The operating power control mode cannot be switched while*

*// the flash memory is being programmed or erased (P/E).*

#### Properties

Prototyped in file "r\_lpc\_rx\_if.h"

#### Description

Depending upon the mode chosen and the MCU, the maximum speed of the internal clocks ICLK, PCLKB, PCLKD and FCLK is limited. For example, in Low-Speed operating mode on the RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23E-B, RX23W, RX260, RX261, only the sub-clock can be used as the system clock. See Table 11.3 (RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N) and Table 11.4 (RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23E-B, RX23W, RX260, RX261) in the Hardware manual for clock limitations. If the argument to this function cannot support the current internal clock frequencies, then an error is returned. When switching the clock source from a lower frequency to a higher frequency, make certain that the operating power control mode is configured to support the range. Failure to do so will result in improper CPU operation.

#### Example

```
lpc_err_t err;

err = R_LPC_OperatingModeSet (LPC_OP_MIDDLE_SPEED);
```

**Special Notes:**

When switching operating power control modes and internal clock frequencies, it is important to first make sure that the frequencies of internal clocks are set within the range supported by the operating power control mode. When moving between operating power control modes/frequencies, use the following sequence:

1. Moving from low power and low internal frequencies to higher power and higher clock frequencies:
  - a. Use `R_LPC_OperatingModeSet ()` to move to higher power operating mode.
  - b. Increase internal clock frequencies
2. Moving from high power and high internal clock frequencies to low power and low internal frequencies:
  - a. Decrease internal clock frequencies
  - b. Use `R_LPC_OperatingModeSet ()` to move to lower power operating mode.

---

## R\_LPC\_LowPowerModeConfigure ()

---

This function configures the low power consumption modes (see [Table 1.2: Low Power Consumption modes](#)) when the WAIT instruction is executed.

### Format

```
lpc_err_t R_LPC_LowPowerModeConfigure (  
    lpc_low_power_mode_t e_mode  
)
```

### Parameters

*lpc\_low\_power\_mode\_t e\_mode*

The modes for all supported MCUs are specified in enum [lpc\\_low\\_power\\_mode\\_t](#).

### Return Values

*LPC\_SUCCESS:*

### Properties

Prototyped in file "r\_lpc\_rx\_if.h"

### Description

This function configures the MCU for the different Low Power Consumption modes shown in [Table 1.2: Low Power Consumption modes](#)

. Note that this function does not activate the low power mode, but configures the registers for the specified mode. To activate the low power mode, use the R\_LPC\_LowPowerModeActivate() function.

The CPU will be stopped once any of these modes are activated; however a few of the peripherals and clocks can operate in these modes. For more details refer to the User's Manual: Hardware.

### Special Notes:

None

## **R\_LPC\_LowPowerModeActivate ()**

This function activates the Low Power Consumption mode configured in R\_LPC\_LowPowerModeConfigure().

### **Format**

```
lpc_err_t R_LPC_LowPowerModeActivate (
    void (*pcallback)(void* pdata)
)
```

### **Parameters**

*void (\*pcallback)(void\* pdata)*

Function to be called before activating low power mode.

### **Return Values**

*LPC\_SUCCESS:*

*LPC\_ERR\_OSC\_STOP\_ENABLED: // Cannot enter software standby if oscillation stop detection // is enabled.*

*LPC\_ERR\_CLOCK\_EXCEEDED: // Clock exceeds the limit of the operating power control mode.*

*LPC\_ERR\_ILL\_CLOCK\_SOURCE: // Illegal clock when sleep mode return clock switching is enabled*

*LPC\_ERR\_ILL\_MAIN\_CLK\_FREQ: // Clock freq. exceeds the limit of the sleep return clock.*

*LPC\_ERR\_DEEP\_SLEEP\_STATUS: // The condition error for a deep sleep mode*

*LPC\_ERR\_ILLEGAL // Illegal operation other than above*

### **Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

### **Description**

This function activates the low power mode by calling the wait() function. The hardware manual specifies the sequence for entering low power mode as follows:

1. Disable interrupts.
2. Configure the interrupt source to wake the MCU up from the low power mode.
3. Ensure that the last IO register write is successful.
4. Execute the wait instruction to enter the low power mode. The wait instruction will internally enable interrupts.

This function implements the sequence as follows:

1. Disable interrupts.
2. Call the callback function specified by the argument. The callback function should configure the wake-up interrupt source and make sure that the last IO register write is complete before returning. The user can pass a FIT\_NO\_FUNC pointer if the interrupt has already been configured.
3. Execute the wait instruction.

When this function is executed, an error is returned under the following conditions.

**Table 3.1 Limitations and Return Values when Entering Sleep Mode**

Limitation	Return Value on an Error	CPU
When sleep mode return clock switching is enabled, the sub-clock must be selected.	LPC_ERR_ILL_CLOCK_SOURCE	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23E-B, RX23W, RX260, RX261
When sleep mode return clock switching is enabled, the system clock or the sub-clock must be selected.	LPC_ERR_ILL_CLOCK_SOURCE	RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
When the operating power control mode after returning from sleep mode is middle speed mode, HOCO cannot be selected as the return clock.	LPC_ERR_ILL_CLOCK_SOURCE	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23E-B, RX23W, RX260, RX261
When the operating power control mode after returning from sleep mode is middle speed mode 2, the main lock cannot be selected as the return clock.	LPC_ERR_ILL_CLOCK_SOURCE	RX260, RX261
The PLL and PLL2 are only usable if VCC is no less than 1.8V	LPC_ERR_CLOCK_EXCEEDED	RX260, RX261
When the operating power control mode after returning from sleep mode is middle speed mode, and the main clock is selected as the sleep mode return clock, the internal clock must be set to comply with the limitation of the middle speed mode.	LPC_ERR_ILL_MAIN_CLK_FREQ	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23E-B, RX23W, RX260, RX261
When HOCO is selected as the sleep mode return clock, HOCO must be powered on.	LPC_ERR_ILL_CLOCK_SOURCE	RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N

**Table 3.2 Limitations and Return Values when Entering All-Module Clock Stop Mode**

Limitation	Return Value on an Error	CPU
The module stop control register must be specified to meet the conditions of all-module clock stop mode.	LPC_ERR_ILLEGAL	RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
All-module clock stop mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N

**Table 3.3 Limitations and Return Values when Entering Deep Sleep Mode**

Limitation	Return Value on an Error	CPU
The MSTPCRA.MSTPA28 bit must be set to 1 (transition to the module-stop state for DMAC/DTC is made) before entering deep sleep mode.	LPC_ERR_DEEP_SLEEP_STATUS	RX110, RX111, RX113, RX130, RX140, RX14T, RX230, RX231, RX23E-B, RX23W, RX260, RX261
Deep sleep mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX110, RX111, RX113, RX130, RX140, RX14T, RX230, RX231, RX23E-B, RX23W, RX260, RX261

**Table 3.4 Limitations and Return Values when Entering Software Standby Mode**

Limitation	Return Value on an Error	CPU
When the oscillation stop detection function is enabled, software standby mode cannot be entered.	LPC_ERR_OSC_STOP_ENABLED	RX110, RX111, RX113, RX130, RX140, RX14T, RX230, RX231, RX23E-B, RX23W, RX260, RX261, RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
Enter software standby mode while the DMAST.DMST bit is 0.	LPC_ERR_ILLEGAL	RX230, RX231, RX23E-B, RX23W, RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
Enter software standby mode while the DTCST.DTCST bit is 0.	LPC_ERR_ILLEGAL	RX110, RX111, RX113, RX130, RX140*1, RX14T, RX230, RX231, RX23E-B, RX23W, RX260*1, RX261*1, RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
Software standby mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX110, RX111, RX113, RX130, RX140, RX14T, RX230, RX231, RX23E-B, RX23W, RX260, RX261, RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N

Note 1: Except when using DTC in snooze mode on the RX140, RX260, RX261.

**Table 3.5 Limitations and Return Values when Entering Deep Software Standby Mode**

Limitation	Return Value on an Error	CPU
When the oscillation stop detection function is enabled, deep software standby mode cannot be entered.	LPC_ERR_OSC_STOP_ENABLED	RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
Enter deep software standby mode while the DMAST.DMST bit is 0.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
Enter deep software standby mode while the DTCST.DTCST bit is 0.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
Deep software standby mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
When using IWDTC with auto-start mode, deep software standby mode cannot be entered if the OFS0.IWDTCSTP bit is 0 (counting stop is disabled).	LPC_ERR_ILLEGAL	RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
When using IWDTC with register start mode, deep software standby mode cannot be entered if the IWDTCSTPR.SLCSTP bit is 0.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
When voltage monitoring 1 reset is enabled (LVD1CR0.LVD1RI = 1) or voltage monitoring 2 reset is enabled (LVD2CR0.LVD2RI = 1) in the voltage detection circuit, deep software standby mode is not entered.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N
Do not enter software standby mode with HOCO's FLL function enabled (FLLCR1.FLLEN = 1).	LPC_ERR_ILLEGAL	RX671, RX660

**Example**

```
lpc_err_t err;

err = R_LPC_LowPowerModeConfigure (LPC_LP_SLEEP);
err = R_LPC_LowPowerModeActivate (FIT_NO_FUNC);
```

**Special Notes:**

When parameter checking is enabled for the module, this function checks for a variety of conditions that prevent the MCU from entering a low power mode. While it is important to have this feature enabled in the development phase, it can be disabled during release to allow for a more rapid entry into low power modes.

Before entering Deep Sleep or Software Standby mode, ensure that DTC transactions are not pending and the DTC module is stopped.

---

## R\_LPC\_SnoozeModeConfigure ()

---

This function sets the conditions for entering the snooze mode, returning to the software standby mode, or releasing the interrupt source of the snooze mode.

### Format

```
lpc_err_t R_LPC_SnoozeModeConfigure (  
    lpc_snooze_mode_t * snooze_mode  
)
```

### Parameters

*lpc\_snooze\_mode\_t \* snooze\_mode*

#### *snooze\_mode->snooze\_operation*

Select the conditions for entering snooze mode and returning to software standby mode.

See Table 3.6: parameter description (snooze\_operation) .

#### *snooze\_mode->snooze\_release*

Select the interrupt source to be released from the snooze mode.

See Table 3.7: parameter description (snooze\_release) .

#### *snooze\_mode->snooze\_interrupt*

Sets the interrupt priority level and callback function for the snooze release interrupt.

See Table 3.8: Parameter description (snooze\_interrupt) .

### Return Values

*LPC\_SUCCESS*

*LPC\_ERR\_ILLEGAL*

### Properties

Prototyped in file "r\_lpc\_rx\_if.h"

### Description

This function sets the conditions for entering the snooze mode, returning to the software standby mode or releasing from the snooze mode.

When using the snooze release interrupt to release snooze mode, set the conditions for the snooze release interrupt, and set the interrupt priority level and callback function. If you do not want to use the snooze release interrupt, set *LPC\_SNZ\_RESET* in the snooze release interrupt condition (*snooze\_release*). Setting *LPC\_SNZ\_RESET* disables the snooze release interrupt and ignores the interrupt priority level and callback function settings.

For the peripheral functions that can be operated in snooze mode, refer to the user's Hardware manual. See Tables **Table 3.6** to **Table 3.8** for parameter settings. This function can only be used on devices that have snooze mode.

**Table 3.6 Parameter description (snooze\_operation)**

Macro	define	description
LPC_SNZ_RESET	(0x0000)	Initialize the setting information.
LPC_SNZ_SCI5_REQ_EXIT	(0x0002)	SCI5 is placed in the snooze mode on detection of the falling edge of RXD5. It is placed back in the software standby mode when the received data do not match the value of the CDR register of SCI5.
LPC_SNZ_SCI5_DTC_REQ_EXIT	(0x0003)	SCI5 is placed in the snooze mode on detection of the falling edge of RXD5. It is placed back in the software standby mode when the received data do not match the value of the CDR register of SCI5, or once transfer of the received data by the DTC has been completed.
LPC_SNZ_LPT_REQ	(0x0008)	The LPT is placed in the snooze mode in response to the LPT compare match 1, and will not be placed back in the software standby mode, but remains in the snooze mode.
LPC_SNZ_LPT_DTC_REQ_EXIT	(0x000c)	The LPT is placed in the snooze mode in response to the LPT compare match 1, and will be placed back in the software standby mode once a single round of the DTC transfer triggered by the LPT compare match 1 has been completed.
LPC_SNZ_S12AD_REQ	(0x0020)	The S12AD is placed in the snooze mode in response to the LPT compare match 1, and perform A/D conversion, and will not be placed back in the software standby mode, but remains in the snooze mode.
LPC_SNZ_S12AD_DTC_REQ_EXIT	(0x0030)	The S12AD is placed in the snooze mode in response to the LPT compare match 1, and perform A/D conversion, and will be placed back in the software standby mode once a single round of the DTC transfer triggered by the end of A/D conversion has been completed.
LPC_SNZ_CTSU_REQ_EXIT	(0x0080)	The CTSU is placed in the snooze mode in response to the LPT compare match 1, and the measurement operation of the CTSU is started, and will be placed back in the software standby mode on request of the end of the snooze mode.
LPC_SNZ_REMC_REQ_EXIT	(0x0200)	The REMC is placed in the snooze mode in response to start of a clock request by the REMC, and will be placed back in the software standby mode once completion of the clock request by the REMC has been detected.
LPC_SNZ_S12AD_2SEL_REQ_EXIT	(0x0800)	The S12AD is placed in the snooze mode in response to an LPT compare match 1, and will be placed back in the software standby mode if the S12AD comparison conditions are not met.
LPC_SNZ_S12AD_3SEL_REQ_EXIT	(0x2000)	The S12AD is placed in the snooze mode in response to an LPT compare match 1, and will be placed back in the software standby mode if the S12AD comparison conditions are met.
LPC_SNZ_DTC_ENABLE	(0x8000)	The DTC transfer is enabled in the snooze mode.

Table 3.7 Parameter description (snooze\_release)

Macro	define	description
LPC_SNZ_RESET	(0x0000)	Initialize the setting information.
LPC_SNZ_SCI5_ERROR_RELEASE	(0x0001)	The SCI5 reception error is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_SCI5_FULL_RELEASE	(0x0004)	The SCI5 reception data full is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_SCI5_DTC_RELEASE	(0x0008)	The DTC transfer completion event in response to the SCI5 reception data full is selected for the interrupt of release from the snooze mode.
LPC_SNZ_LPT_MATCH1_RELEASE	(0x0010)	The LPT compare match 1 is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_LPT_DTC_RELEASE	(0x0020)	The DTC transfer completion event in response to the LPT compare match 1 is selected for the interrupt of release from the snooze mode.
LPC_SNZ_S12AD_RELEASE	(0x0040)	The completion of the S12AD conversion is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_S12AD_DTC_RELEASE	(0x0080)	The DTC transfer completion event in response to the completion of the S12AD conversion is selected for the interrupt of release from the snooze mode.
LPC_SNZ_CTSU_RELEASE	(0x0100)	The completion of the CTSU measurement is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_S12AD2_RELEASE	(0x0400)	The S12AD comparison conditions non-satisfaction event is selected for release from the snooze mode.
LPC_SNZ_S12AD3_RELEASE	(0x1000)	The S12AD comparison conditions satisfaction event is selected for release from the snooze mode.

Table 3.8 Parameter description (snooze\_interrupt)

data structure	Set value	description
priority	type : uint8_t Set value : 0~15	Sets the interrupt priority level for snooze release interrupts. If you do not use the snooze release interrupt, the setting is ignored.
pcallback	type : lpc_snooze_callback_set_t Set value : Function pointer	Sets the callback function for the snooze release interrupt. Set FIT_NO_FUNC if you do not want to use the callback function in the snooze release interrupt. If you do not use the snooze release interrupt, the setting is ignored.

**Example**

```
lpc_err_t err;
lpc_snooze_mode_t snooze_mode;

/* When resetting the snooze mode setting */
snooze_mode.snooze_operation = LPC_SNZ_RESET;
snooze_mode.snooze_release = LPC_SNZ_RESET;
snooze_mode.snooze_interrupt.priority = 0;
snooze_mode.snooze_interrupt.pcallback = FIT_NO_FUNC;

/* When the snooze mode ends (software standby transition) due to a mismatch in
the received data of SCI5, and the snooze mode is canceled when the received
data is full */
snooze_mode.snooze_operation = LPC_SNZ_SCI5_REQ_EXIT;
snooze_mode.snooze_release = LPC_SNZ_SCI5_FULL_RELEASE;
snooze_mode.snooze_interrupt.priority = 5;
snooze_mode.snooze_interrupt.pcallback = FIT_NO_FUNC;

/* When the snooze mode ends (software standby transition) after DTC transfer of
received data of SCI5, and the snooze mode is canceled by DTC transfer end
interrupt */
snooze_mode.snooze_operation = LPC_SNZ_SCI5_DTC_REQ_EXIT | LPC_SNZ_DTC_ENABLE;
snooze_mode.snooze_release = LPC_SNZ_SCI5_DTC_RELEASE;
snooze_mode.snooze_interrupt.priority = 5;
snooze_mode.snooze_interrupt.pcallback
=(lpc_snooze_callback_set_t)&lpc_callback;
/* When using a callback function with a snooze release interrupt */

err = R_LPC_SnoozeModeConfigure (&snooze_mode);
err = R_LPC_LowPowerModeConfigure (LPC_LP_SW_STANDBY);
err = R_LPC_LowPowerModeActivate (FIT_NO_FUNC);
```

**Special Notes:**

- In order to operate each peripheral function in snooze mode, the conditions for each peripheral function to be used must be satisfied before transitioning to software standby. For details, refer to the power consumption reduction function in the user's manual hardware.
- The snooze mode release interrupt condition is valid even in operation modes other than snooze mode. If you do not want to generate a snooze release interrupt in an operation mode other than the snooze mode, please use the settings to initialize the snooze mode to cancel the snooze mode before transitioning to software standby.

## R\_LPC\_ReturnClockSwitch ()

This function configures the MCU to switch clock sources on waking up from Sleep mode.

### Format

```
lpc_err_t R_LPC_ReturnClockSwitch (
    lpc_clock_switch_t e_clock_source,
    bool enable
)
```

### Parameters

*lpc\_clock\_switch\_t e\_clock\_source*

This parameter selects the clock source to be used at the time of release from sleep mode. The supported clock sources are specified in the enum [lpc\\_clock\\_switch\\_t](#) in section 2.9.3.

*bool enable*

Enables or disables clock source switching at the time of release from sleep mode. The clock source selected by *e\_clock\_source* is enabled only when *enable* = 1.

### Return Values

*LPC\_SUCCESS:*

### Properties

Prototyped in file "r\_lpc\_rx\_if.h"

### Description

This function will configure the return clock switching parameter that allows the clock source to be switched on returning from Sleep Mode to the HOCO, LOCO or Main Clock. The following items have to be followed to allow for Return Clock Switching:

1. RX110, RX111, RX113 MCUs :
  - When entering Sleep Mode, the system clock should be the Sub-Clock oscillator. On exiting sleep, the operating mode will return to whatever the operating power control mode was before entering sleep.
  - If the Main OSC is chosen as the Sleep Return clock source, middle speed mode is the return mode. Make sure the internal clock after returning from sleep mode does not exceed the limits of middle speed mode.
2. RX130, RX140, RX230, RX231, RX23E-B, RX23W, RX260, RX261 MCUs :
  - When entering Sleep Mode, the system clock should be the Sub-Clock oscillator. On exiting sleep, the operating mode will return to whatever the operating power control mode was before entering sleep.
  - If Middle Speed mode is the return mode and the Main OSC is chosen as the Sleep Return clock source, make sure the internal clock after returning from sleep mode does not exceed the limits of middle speed mode.
3. RX26T, RX64M, RX65N, RX660, RX66N, RX671, RX71M, RX72M, RX72N MCUs:
  - When entering sleep mode, select LOCO or the sub-clock as the clock source.

### Example

```
lpc_err_t err;

err = R_LPC_ReturnClockSwitch (LPC_MAIN_OSC, true);
```

### Special Notes:

None.

---

**R\_LPC\_GetVersion ()**

---

This function returns the driver version number at runtime.

**Format**

```
uint32_t R_LPC_GetVersion (void);
```

**Parameters**

*none*

**Return Values**

*Version number.*

**Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

**Description**

Returns the version of this module. The version number is encoded such that the top 2 bytes are the major version number and the bottom 2 bytes are the minor version number.

**Example**

```
uint32_t version;  
  
version = R_LPC_GetVersion ();
```

**Special Notes:**

None

## 4. Usage Examples

### 4.1 Example sequence for entering higher power operating modes, RX1xx MCUs

The RX110, RX111, RX113, RX130 MCUs have internal regulators that control power to the chip. Configuring the regulators to supply higher power before moving into a higher power state is necessary for proper operation.

Below is an example that shows the sequence of operations and API calls necessary to move from a lower power state to a higher powered one. It is assumed that at the start of this sequence, the system clock source is the sub-clock and the operating power control mode is Low Speed mode.

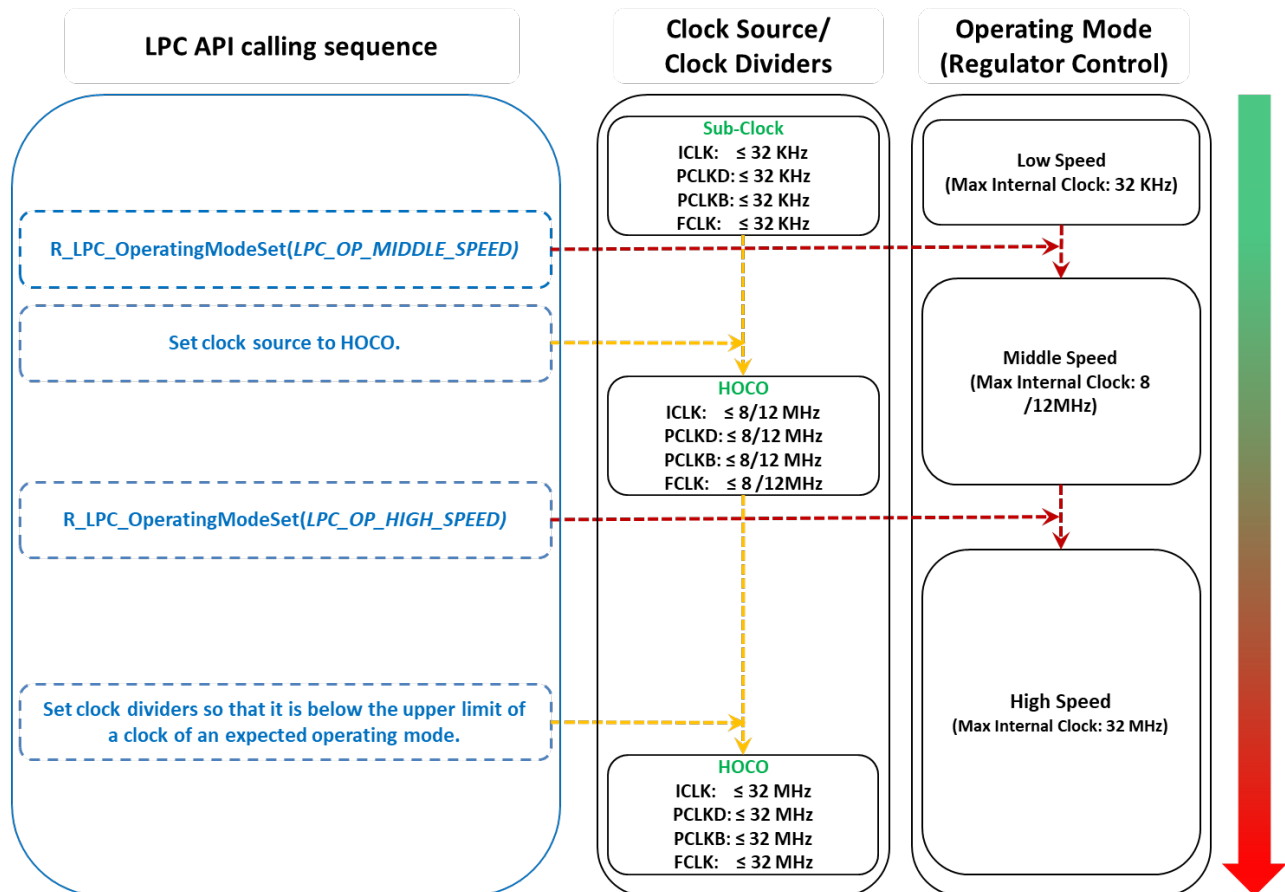


Figure 4.1 Sequence for moving from a low power to high power state (RX110, RX111, RX113, RX130)

### 4.2 Example sequence for entering lower power operating modes, RX1xx MCUs

When moving to lower power states, it is important to first move to the lower power state before switching the regulator down for lower supply voltage.

Below is an example that shows the sequence of operations and API calls necessary to move from a higher power state to a lower powered one. It is assumed that at the start of this sequence, the system clock source is the HOCO and the operating power control mode is High Speed mode.

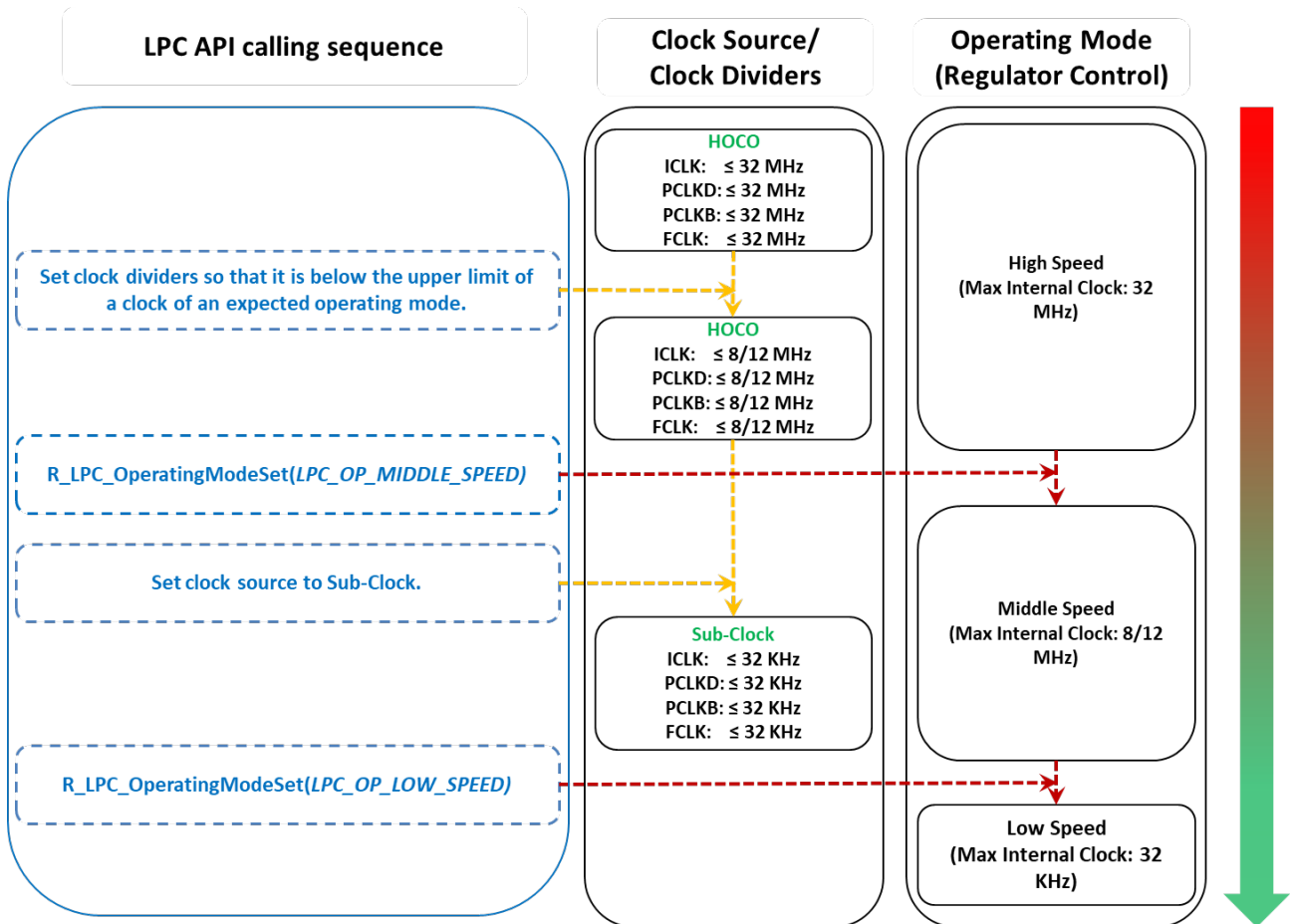


Figure 4.2 Sequence for moving from a high power to low power state (RX110, RX111, RX113, RX130)

## 5. Demo Projects

Demo projects include function `main()` that utilizes the FIT module and its dependent modules (e.g. `r_bsp`). This FIT module includes the following demo projects.

---

### 5.1 `lpc_demo_rskrx231`, `lpc_demo_rskrx64m`, `lpc_demo_rskrx65n`, `lpc_demo_rskrx231_gcc`, `lpc_demo_rskrx64m_gcc`, `lpc_demo_rskrx65n_gcc`

---

These demo programs for LPC FIT module are designed for Renesas RSKRX231, RSKRX64M, RSKRX65N demo boards. The program demonstrates how to use the `R_LPC_LowPowerModeConfigure ()` to configure Low Power Consumption modes, then use `R_LPC_LowPowerModeActivate ()` to activate Low Power Consumption mode, and wake up with an IRQ interrupt. Once the code is compiled and downloaded to the target board and is running, LED0 will turn on after initialization. By default, the MCU will be in Operating Power Control Modes (High-Speed Mode), LED1 will blink continuously. After 10 seconds, the MCU goes into Low Power Consumption mode (LPC\_LP\_SLEEP mode), LED1 will turn OFF. After user press SW1, the MCU exits Low Power Consumption Mode, LED1 will blink continuously.

#### Setup and Execution

1. Connect the RSK board to the PC (using Renesas E1 Emulator). Build the sample application, download it to the board and run it
2. By checking the log, confirm that the program configures the MCU for LPC\_LP\_SLEEP mode
3. By checking the log and LEDs, confirm that the program activates LPC\_LP\_SLEEP mode
4. Press SW1 to wake up with an IRQ interrupt.

Notes: In step (3), a message will be printed in the Renesas Debug Virtual Console window to prompt the user to press SW1.

#### Boards Supported

RSKRX231, RSKRX64M, RSKRX65N

---

## 5.2 Adding a Demo to a Workspace

---

Demo projects are found in the FITDemos subdirectory of the distribution file for this application note. To add a demo project to a workspace, select *File >> Import >> General >> Existing Projects into Workspace*, then click "Next". From the Import Projects dialog, choose the "Select archive file" radio button. "Browse" to the FITDemos subdirectory, select the desired demo zip file, then click "Finish".

---

## 5.3 Downloading Demo Projects

---

Demo projects are not included in the RX Driver Package. When using the demo project, the FIT module needs to be downloaded. To download the FIT module, right click on this application note and select "Sample Code (download)" from the context menu in the *Smart Browser >> Application Notes* tab.

## 6. Appendices

### 6.1 Confirmed Operation Environment

This section describes confirmed operation environment for the LPC FIT module.

**Table 6.1 Confirmed Operation Environment (Rev. 1.41)**

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 7.3.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00. Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.41

**Table 6.2 Confirmed Operation Environment (Rev. 1.42)**

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 7.5.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00. Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.42
Board used	Renesas Solution Starter Kit for RX23W (product No.: RTK5523Wxxxxxxxxxx)

**Table 6.3 Confirmed Operation Environment (Rev. 2.00)**

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 7.6.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00. Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 4.8.4.201902 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.12.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.00
Board used	Renesas Solution Starter Kit for RX23W (product No.: RTK5523Wxxxxxxxxxx)

Table 6.4 Confirmed Operation Environment (Rev. 2.01)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 7.7.0 IAR Embedded Workbench for Renesas 4.14.01
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00. Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.201904 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.14.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.01
Board used	Renesas Starter Kit for RX130 (product No.: RTK5005130xxxxxxx) Renesas Starter Kit for RX231 (product No.: R0K505231xxxxxx) Renesas Starter Kit+ for RX64M (product No.: R0K50564Mxxxxxx) Renesas Starter Kit+ for RX65N (product No.: RTK500565Nxxxxxxx) Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx) Renesas Starter Kit+ for RX72N (product No.: RTK5572Nxxxxxxxxxx)

Table 6.5 Confirmed Operation Environment (Rev. 2.02)

Item	Contents
Integrated development environment	Renesas Electronics e2 studio 2021-01 IAR Embedded Workbench for Renesas 4.20.01
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00. Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202004 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.20.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.02
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671Exxxxxxxx)

**Table 6.6 Confirmed Operation Environment (Rev. 2.03)**

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2021-07 IAR Embedded Workbench for Renesas 4.20.01
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00. Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202102 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.20.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.03
Board used	Target board for RX140 (product No.:RTK5RX140xxxxxxx)

**Table 6.7 Confirmed Operation Environment (Rev. 2.04)**

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2022-04 IAR Embedded Workbench for Renesas 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.04.00. Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202104 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.04
Board used	Renesas Starter Kit for RX660 (product No.:RTK556609HCxxxxxBJ)

Table 6.8 Confirmed Operation Environment (Rev. 2.10)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2022-07 IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.04.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202104 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.10
Board used	Renesas Starter Kit for RX231 (product No.: R0K505231Sxxxxxx) Renesas Starter Kit for RX64M (product No.: R0K50564Mxxxxxx) Renesas Starter Kit+ for RX65N (product No.: RTK5005651Cxxxxxx)

Table 6.9 Confirmed Operation Environment (Rev. 2.20)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2022-10 IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.05.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202204 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.20
Board used	Renesas Flexible Motor Control Kit for RX26T(product No.:RTK0EMXE70S00020BJ)

Table 6.10 Confirmed Operation Environment (Rev. 2.30)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2023-04 IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.05.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202204 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.30
Board used	Renesas Solution Starter Kit for RX23E-B (product No.: RTK0ES1001C00001BJ)

Table 6.11 Confirmed Operation Environment (Rev. 2.40)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2024-07 IAR Embedded Workbench for Renesas RX 5.10.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.06.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202405 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 5.10.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.40
Board used	Evaluation Kit for RX261 (product No.: RTK5EK2610S00011BJ)

Table 6.12 Confirmed Operation Environment (Rev. 2.50)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2024-07 IAR Embedded Workbench for Renesas RX 5.10.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.06.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202405 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 5.10.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.50
Board used	Evaluation Kit for RX261 (product No.: RTK5EK2610S00011BJ)

Table 6.13 Confirmed Operation Environment (Rev. 2.51)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2025-01 IAR Embedded Workbench for Renesas RX 5.10.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.07.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202411 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 5.10.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.51
Board used	-

Table 6.14 Confirmed Operation Environment (Rev. 2.52)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2025-01 IAR Embedded Workbench for Renesas RX 5.10.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.07.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.3.0.202411 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 5.10.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.52
Board used	-

Table 6.15 Confirmed Operation Environment (Rev. 2.60)

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 2025-10 IAR Embedded Workbench for Renesas RX 5.20.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.07.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 14.2.0.202505 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 5.20.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.60
Board used	Renesas Flexible Motor Control CPU Board for RX14T (product No.: RTK0EMXH30C01000BJ)

## 6.2 Troubleshooting

(1) Q: I have added the FIT module to the project and built it. Then I got the error: Could not open source file "platform.h".

A: The FIT module may not be added to the project properly. Check if the method for adding FIT modules is correct with the following documents:

- Using CS+:

Application note "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)"

- Using e<sup>2</sup> studio:

Application note "Adding Firmware Integration Technology Modules to Projects (R01AN1723)"

When using this FIT module, the board support package FIT module (BSP module) must also be added to the project. Refer to the application note "Board Support Package Module Using Firmware Integration Technology (R01AN1685)".

(2) Q: I have added the FIT module to the project and built it. Then I got the error: This MCU is not supported by the current r\_lpc\_rx module.

A: The FIT module you added may not support the target device chosen in your project. Check the supported devices of added FIT modules.

**Revision History**

Rev.	Date	Description	
		Page	Summary
1.40	Oct. 01, 2016	-	Initial release
1.41	Apr. 01, 2019	-	Changes associated with functions: Added support setting function of configuration option Using GUI on Smart Configurator. [Description] Added a setting file to support configuration option setting function by GUI.
		1	Changed Related Document.
		4	Moved 1.1 LPC FIT Module. Changed 1.2 Overview of the LPC FIT Module.
		5	Moved 1.3 API Overview. Changed 1.4 State Transition Diagram.
		8	Deleted Hardware Resource Requirement. Deleted Limitations. Changed 2.3 Supported Toolchains. Added 2.4 Interrupt Vector. Changed 2.5 Header Files. Changed 2.6 Integer Types.
		9	Changed 2.7 Configuration Overview.
		10	Changed 2.8 Code Size.
		12	Changed 2.9 Parameters.
		13	Changed 2.10 Return Values. Added 2.11 Callback Function.
		14	Changed 2.12 Adding the FIT Module to Your Project.
		15	Added 2.13 “for”, “while” and “do while” statements.
		25	Changed R_LPC_GetVersion.
		31	Added 5.5 Downloading Demo Projects.
		32	Added 6.1 Confirmed Operation Environment.
		33	Added 6.2 Troubleshooting.
1.42	Jul. 01, 2019	-	Added support for RX23W.
		23	Added RX230 to the description for R_LPC_ReturnClockSwitch ().
2.00	Nov. 14, 2019	-	Deleted RX210 from target device.
		1	Deleted “Related Documents”.
		9 26	Supported the following compilers. - GCC for Renesas RX - IAR C/C++ Compiler for Renesas RX
		13	Deleted the section of Target devices describing “WAIT_LOOP”
		23	Corrected typographic error at the “Format” content of R_LPC_GetVersion ().
		26	Deleted the section of “Demo Projects”.

Rev.	Date	Description	
		Page	Summary
2.01	Jun. 10, 2020	-	Added support for RX65N, RX66N, RX72M and RX72N.
		1	Added Target Compilers.
		7	Added revision of dependent r_bsp module in 2.2 Software Requirements.
		9	Changed 2.8 Code Size.
		12	Changed 2.12 Adding the FIT Module to Your Project.
		14-23	Deleted "Reentrant" for each API in 3 API Functions.
		27	Added Table 5.4 Confirmed Operation Environment (Rev. 2.01).
		Program	Fixed the following. [Target device] All devices. [Description] Changed processing so that there is a register that may be accessed from multiple peripheral functions at the same time, and the atomicity of writing to that register can be ensured.
2.02	Apr. 02, 2021	-	Added support for RX671.
2.03	Jul. 31, 2021	-	Added support for RX140.
		1	Added target device for RX140.
		4	Added Operating Power Control modes for RX140 in 1.2 Overview of the LPC FIT Module.
		4	Added Low Power Consumption modes for RX140 in 1.2 Overview of the LPC FIT Module.
		5	Added API function (R_LPC_SnoozeModeConfigure) .
		8	Added the state transition diagram of the LPC FIT module of RX140 in 1.4 State Transition Diagram.
		9	Changed the revision of the dependent r_bsp module in 2.2 Software Requirements.
		9	Added interrupt vector table for snooze mode in 2.4 Interrupt Vector.
		11	Changed 2.8 Code Size.
		12	Added R_LPC_OperatingModeSet Data Types for RX140 in 2.9.1 R_LPC_OperatingModeSet Data Types.
		13	Added R_LPC_SnoozeModeConfigure Data Types for RX140 in 2.9.4 R_LPC_SnoozeModeConfigure Data Types.
		14	Added the description of Callback Function in 2.11 Callback Function.
		24	Added R_LPC_SnoozeModeConfigure function.
		33	Added Table 5.6 Confirmed Operation Environment (Rev. 2.03).

Rev.	Date	Description	
		Page	Summary
2.04	Dec. 31, 2021	-	Added support for RX660.
		1	Added target device for RX660.
		4	Added Low Power Consumption modes for RX660 in 1.2 Overview of the LPC FIT Module.
		4	Added Operating Power Control modes for RX660 in 1.2 Overview of the LPC FIT Module.
		5	Added 1.3 Using the LPC FIT module.
		6	Added Figure 1-3 in state transition diagram.
		9	Added the state transition diagram of the LPC FIT module of RX660 in 1.4 State Transition Diagram.
		12	Changed 2.8 Code Size.
		13	Added R_LPC_LowPowerModeConfigure Data Types for RX660 in 2.9.2 R_LPC_LowPowerModeConfigure Data Types.
		22	Added RX660 limitations and return value in Table 3.1.
		22	Added RX660 limitations and return value in Table 3.2.
		23	Added RX660 limitations and return value in Table 3.4.
		24	Added RX660 and RX671 limitations and return value in Table 3.5.
		29	Added RX660 description in 3.5 R_LPC_ReturnClockSwitch ().
		35	Added Table 5.7 Confirmed Operation Environment (Rev. 2.04).
		2.10	Jun. 28, 2022
33	Added RSKRX231, RSKRX64M, RSKRX65N to "5. Demo Projects".		
37	6.1 Confirmed Operation Environment: Added Table for Rev. 2.10		
Program	Added new demo projects		
2.20	Aug. 15, 2022	-	Added support for RX26T.
		1	Added target device for RX26T.
		4	Added Low Power Consumption modes for RX26T in 1.2 Overview of the LPC FIT Module.
		4	Added Operating Power Control modes for RX26T in 1.1 Overview of the LPC FIT Module.
		6	Added Figure 1-5 in state transition diagram.
		10	Added the state transition diagram of the LPC FIT module of RX26T in 1.5 State Transition Diagram.
		13	Changed 2.8 Code Size.
		15, 16	Added R_LPC_LowPowerModeConfigure Data Types for RX26T in 2.9.2 R_LPC_LowPowerModeConfigure Data Types.
		16	Added R_LPC_ReturnClockSwitch Data Types for RX26T in 2.9.3 R_LPC_ReturnClockSwitch Data Types.
		23	Added RX26T limitations and return value in Table 3.1.
		23	Added RX26T limitations and return value in Table 3.2.
		24	Added RX26T limitations and return value in Table 3.4.
		30	Added RX26T description in R_LPC_ReturnClockSwitch ().
		38	Table 6.9: Confirm Operation Environment: Added Table for Rev. 2.20.
		Program	Added support for RX26T

Rev.	Date	Description	
		Page	Summary
2.30	May. 29, 2023	-	Added support for RX23E-B.
		1	Added target device for RX23E-B.
		4	Added Operating Power Control modes for RX23E-B in 1.2 Overview of the LPC FIT Module.
		4	Added Low Power Consumption modes for RX23E-B in 1.2 Overview of the LPC FIT Module.
		6	Added RX23E-B in Figure 1.1.
		13	Changed 2.8 Code Size.
		14	Added R_LPC_OperatingModeSet Data Types for RX23E-B in 2.9.1 R_LPC_OperatingModeSet Data Types
		14	Added R_LPC_LowPowerModeConfigure Data Types for RX23E-B in 2.9.2 R_LPC_LowPowerModeConfigure Data Types
		15	Added R_LPC_ReturnClockSwitch Data Types for RX23E-B in 2.9.3 R_LPC_ReturnClockSwitch Data Types
		16	Deleted the description of FIT configurator from "2.12 Adding the FIT Module to Your Project"
		18	Added RX23E-B description in R_LPC_OperatingModeSet ().
		22	Added RX23E-B limitations and return value in Table 3.1.
		23	Added RX23E-B limitations and return value in Table 3.3.
		23	Added RX23E-B limitations and return value in Table 3.4.
		29	Added RX23E-B description in R_LPC_ReturnClockSwitch ().
		38	Table 6.10 Confirm Operation Environment: Added Table for Rev. 2.30.
		Program	Added support for RX23E-B

Rev.	Date	Description	
		Page	Summary
2.40	Jun. 28, 2024	1, 4, 8, 11, 14, 15, 22-24	Added support for RX260, RX261.
		13	Changed 2.8 Code Size.
		18	Added RX260, RX261 description in R_LPC_OperatingModeSet ().
		21	Added return value LPC_ERR_CLOCK_EXCEEDED for R_LPC_LowPowerModeActivate ().
		22	Added limitation on middle-speed operating mode 2, the main clock cannot be selected for for RX260, RX261.
		22	Added limitation about the PLL and PLL2 are only usable if VCC is no less than 1.8V.
		27	Table 3.6 Parameter description (snooze_operation): Added LPC_SNZ_REMC_REQ_EXIT, LPC_SNZ_S12AD_2SEL_REQ_EXIT, and LPC_SNZ_S12AD_3SEL_REQ_EXIT macros.
		28	Table 3.7 Parameter description (snooze_release): Added LPC_SNZ_S12AD2_RELEASE and LPC_SNZ_S12AD3_RELEASE macros.
		30	Added RX260, RX261 description in R_LPC_ReturnClockSwitch ().
		39	Table 6.11 Confirm Operation Environment: Added Table for Rev. 2.40.
		Program	Added support for RX260, RX261. Removed duplicate macros(LPC_CLOCK_ACTIVE and LPC_CLOCK_INACTIVE) for all devices. Modified comment of API R_LPC_OperatingModeSet (), R_LPC_ReturnClockSwitch (), and R_LPC_LowPowerModeActivate () functions.
2.50	Nov. 01, 2024	40	Table 6.12 Confirm Operation Environment: Added Table for Rev. 2.50.
		Program	Moved the restrictions of PLL, PLL2 and main clock oscillator in middle-speed operation mode and middle-speed operation mode 2 to lpc_freq_range_check() and lpc_lowpower_activate_check() functions for RX260, RX261.
2.51	Mar. 15, 2025	40	Table 6.13 Confirm Operation Environment: Added Table for Rev. 2.51.
		Program	Updated FIT Disclaimer and Copyright.
2.52	Oct. 30, 2025	41	Table 6.14 Confirm Operation Environment: Added Table for Rev. 2.52.
		Program	Removed doc folder and updated .rcpc file in FITDemos.
2.60	Nov. 28, 2025	1, 4, 6, 7, 15, 25, 26	Added support for RX14T.
		14	Changed 2.8 Code Size.
		Program	Added support for RX14T. Removed le in Doxygen comment of API function. Modified comment of API function to Doxygen style.

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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